

PCN Number:	20150903002	PCN Date:	2/11/2016
Title:	Datasheet for LP38501-ADJ and LP38503-ADJ		
Customer Contact:	PCN Manager	Dept:	Quality Services
Change Type:			
<input type="checkbox"/> Assembly Site	<input type="checkbox"/> Design	<input type="checkbox"/> Wafer Bump Site	
<input type="checkbox"/> Assembly Process	<input checked="" type="checkbox"/> Data Sheet	<input type="checkbox"/> Wafer Bump Material	
<input type="checkbox"/> Assembly Materials	<input type="checkbox"/> Part number change	<input type="checkbox"/> Wafer Bump Process	
<input type="checkbox"/> Mechanical Specification	<input type="checkbox"/> Test Site	<input type="checkbox"/> Wafer Fab Site	
<input type="checkbox"/> Packing/Shipping/Labeling	<input type="checkbox"/> Test Process	<input type="checkbox"/> Wafer Fab Materials	
		<input type="checkbox"/> Wafer Fab Process	

Notification Details

Description of Change:

Texas Instruments Incorporated is announcing an information only notification etc.

The product datasheet(s) is being updated as summarized below.

The following change history provides further details.



LP38501-ADJ, LP38503-ADJ

SNVS522I –AUGUST 2007–REVISED AUGUST 2015

Changes from Revision H (April 2013) to Revision I

Page

• Added Device Information and Pin Configuration and Functions sections, ESD Rating and updated Thermal Information tables, Feature Description, Device Functional Modes, Application and Implementation, Power Supply Recommendations, Layout, Device and Documentation Support, and Mechanical, Packaging, and Orderable Information sections; remove lead temp from Abs Max table (in POA); remove obsolete heatsinking content; update thermal values	1
• Deleted obsolete heatsinking information for DDPAK/TO-263 package	18

The datasheet number will be changing.

Device Family	Change From:	Change To:
LP38501-ADJ and LP38503-ADJ	SNVS522H	SNVS522I

These changes may be reviewed at the datasheet links provided.

<http://www.ti.com/product/LP38501-ADJ>

Reason for Change:

To more accurately reflect device characteristics.

Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):

No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.

Changes to product identification resulting from this PCN:

None.

Product Affected:

LP38501ATJ-ADJ/NOPB	LP38501TJ-ADJ/NOPB	LP38501TS-ADJ/NOPB	LP38501TSX-ADJ/NOPB
LP38503ATJ-ADJ/NOPB	LP38503TJ-ADJ/NOPB	LP38503TS-ADJ/NOPB	LP38503TSX-ADJ/NOPB

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com